## INTRODUCTION

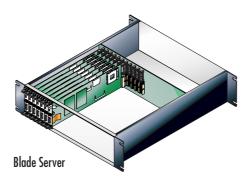
Mole Applicate Acquises the designed to accept Mobile Pentium\* 4 and Mobile Celeron\*
Processor-M series for applications such as thin notebooks and blade servers. These high-density sockets feature low profiles and proven Ball Grid Array (BGA) soldering technology for stable PCB processing.

The new sockets include an easy-to-use cam mechanism and stainless steel cam retainer to prevent wear-and-tear on the housing during use. The terminal includes a dual-beam chamfered contact for good electrical performance, and BGA-interface design to ensure good thermal mismatch control between components and the PCB.

Molex's Micro PGA sockets are part of our growing family of innovative socketing solutions for processor, memory and test applications.

## **Applications:**

Notebook PCs Blade Servers

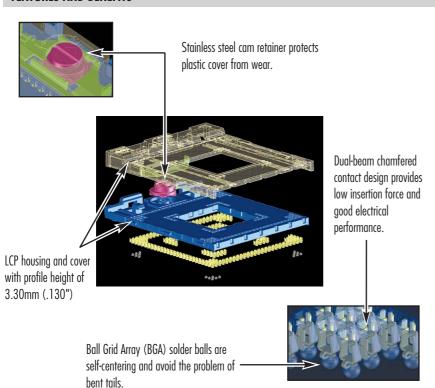


\*Pentium and Celeron are registered trademarks of Intel Corporation

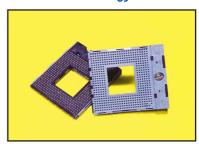
# Micro PGA Socket 478/479 Circuits For Mobile Pentium\* 4 ZIF Type, BGA Mount



#### **FEATURES AND BENEFITS**







Accepts energy-saving Pentium mobile processors
For notebooks, blade servers and small desktop PCs
478 circuits

Small pin layout difference and blue color to differentiate from standard P4-M socket Same features as standard P4-M socket Order No.: 500210-4784

Centrino is a trademark of Intel Corporation

## **SPECIFICATIONS**

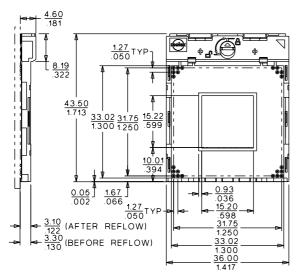
Physical	Housing	Black LCP, UL 94V-0
	Contact	Copper Alloy
	Solder Ball	Tin/Lead, 0.76mm (.030") dia.
	CAM	Stainless Steel
	CAM Holder	Stainless Steel
	Plating—Contact Area	Gold
	Underplating	Nickel
	Operating Temperature	-20 to +90°C

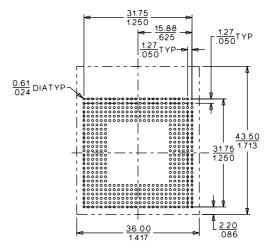
Electrical	Voltage	100V
	Current	0.5A
	Contact Resistance	25 milliohms max.
	Dielectric Withstanding Voltage	AC 360V
	Insulation Resistance	800 Megohms min.
Mechanical	Durability	50 cycles
Reference	Product Specification	PS-51248-005
	Packaging	Hard Tray/ Embossed Tape
	Designed In	Millimeters

# 查询"51248-4782"供应商









PCB LAYOUT: COMPONENT SIDE

## **ORDERING INFORMATION**

Circuits	Order No.	
	Hard Tray	Embossed Tape
478	51248-4782	51248-4784
479	51248-4792	51248-4794



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